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30V P-Channel Power MOSFET



SOP-8



Pin Definition:

1. Source 8. Drain
2. Source 7. Drain
3. Source 6. Drain
4. Gate 5. Drain

Key Parameter Performance

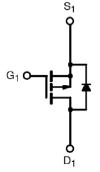
Parameter		Value	Unit	
$V_{ extsf{DS}}$		-30	V	
R _{DS(on)} (max)	V _{GS} =-10V	60	0	
	V _{GS} =-4.5V	90	mΩ	
Q_g		5.1	nC	

Ordering Information

Part No.	Package	Packing		
TSM600P03CS RLG	SOP-8	2.5kps / 13" Reel		

Note: "G" denotes for Halogen- and Antimony-free as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds

Block Diagram



P-Channel MOSFET

Absolute Maximum Ratings (Tc = 25°C unless otherwise noted)

Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V _{DS}	-30	V
Gate-Source Voltage		V_{GS}	±20	V
Continuous Drain Current*	Tc = 25°C	I _D	-4.7	Α
	Tc = 100 ^o C		-3	Α
Pulsed Drain Current (Note 1)		I _{DM}	-18.8	Α
Power Dissipation @ T _C = 25°C		P _D	2.1	W
Operating Junction and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C

Thermal Performance

Parameter	Symbol	Limit	Unit	
Thermal Resistance - Junction to Ambient	R _{OJA}	50	°C/W	

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Electrical Specifications (T_J = 25°C unless otherwise noted)

Parameter	Conditions	Symbol	Min	Тур	Max	Unit
Static						
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A$	BV _{DSS}	-30			V
Drain-Source On-State Resistance	$V_{GS} = -10V, I_D = -3A$	R _{DS(ON)}		44	60	mΩ
	$V_{GS} = -4.5V, I_D = -2A$			73	90	
Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	$V_{GS(TH)}$	-1.2	-1.6	-2.5	V
Zaus Cata Valtana Busin Oriunant	$V_{DS} = -30V, T_{J} = 25^{\circ}C$				-1	μΑ
Zero Gate Voltage Drain Current	$V_{DS} = -24V, T_{J} = 125^{\circ}C$	I_{DSS}			-10	
Gate Body Leakage	$V_{GS} = \pm 20V, V_{DS} = 0V$	I _{GSS}			±100	nA
Forward Transconductance (Note 2)	$V_{DS} = -10V, I_{D} = -3A$	g _{fs}		3.5		S
Dynamic						
Total Gate Charge (Note 2,3)	$V_{DS} = -15V, I_{D} = -3A,$	Q_g		5.1		nC
Gate-Source Charge (Note 2,3)		Q_{gs}		2		
Gate-Drain Charge (Note 2,3)	$V_{GS} = -4.5V$	Q_{gd}		2.2		
Input Capacitance	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	C _{iss}		560		pF
Output Capacitance	$V_{DS} = -15V, V_{GS} = 0V,$	C_{oss}		55		
Reverse Transfer Capacitance	f = 1.0MHz	C_{rss}		40		
Switching						
Turn-On Delay Time (Note 2,3)		t _{d(on)}		3.4		
Turn-On Rise Time (Note 2,3)	$V_{DD} = -15V, I_{D} = -1A,$	t _r		10.8		ns
Turn-Off Delay Time (Note 2,3)	$V_{GS} = -10V$, $R_G = 6\Omega$	$t_{d(off)}$		26.9		
Turn-Off Fall Time (Note 2,3)		t _f		6.9		
Source-Drain Diode Ratings and Ch	aracteristic					
Maximum Continuous Drain-Source	Integral reverse diode in				-4.7	
Diode Forward Current		I _S			-4.7	Α
Maximum Pulse Drain-Source Diode	the MOSFET	I _{SM}			-18.8	Α
Forward Current						
Diode-Source Forward Voltage	$V_{GS} = 0V, I_{S} = -1A$	$V_{\sf SD}$			-1	V

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Note:

- 1. Pulse width limited by safe operating area
- 2. Pulse test: pulse width ≤300µs, duty cycle ≤2%
- 3. Switching time is essentially independent of operating temperature.

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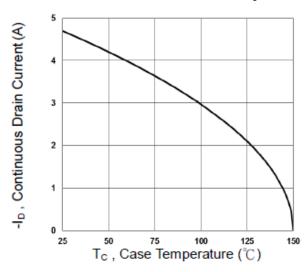


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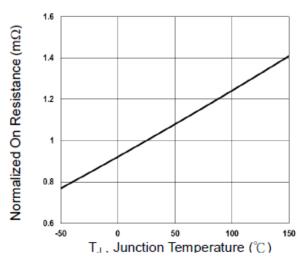
Pb ROHS

Electrical Characteristics Curve

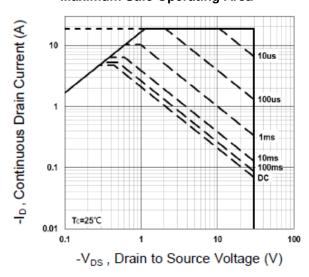
Continuous Drain Current vs. Tc



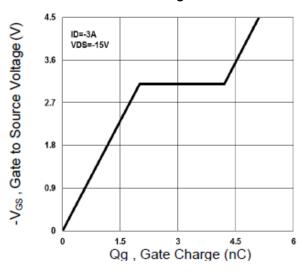
On-Resistance vs. Junction Temperature



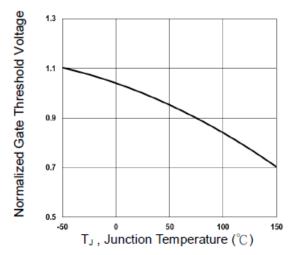
Maximum Safe Operating Area



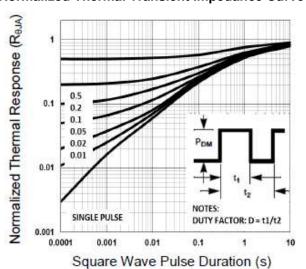
Gate Charge



Threshold Voltage vs. Junction Temperature



Normalized Thermal Transient Impedance Curve



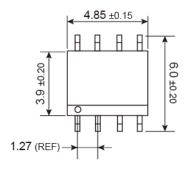
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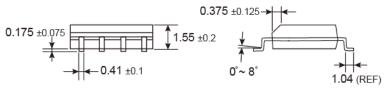


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SOP-8 Mechanical Drawing





Unit: Millimeters

MARKING DIAGRAM



Y = Year Code

M = Month Code for Halogen Free Product (O=Jan, P=Feb, Q=Mar, R=Apl, S=May, T=Jun, U=Jul, V=Aug, W=Sep, X=Oct, Y=Nov, Z=Dec)

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L = Lot Code

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